

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

Detailed Change Description

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages



ВОМ	Old	Newly Added
Adhesive	Ablestik 8290 Ablestik 3230	Hitachi EN4900GC
Molding Compound	Sumitomo G770 Hitachi 9220HF13	Sumitomo G700LA